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Team Nexperia

PEMH9; PIMH9; PUMH9

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

Rev. 5 — 12 November 2013

Product data sheet

1. Product profile

1.1 General description

NPN/NPN double Resistor-Equipped Transistors (RET) in Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

| Type number | Package | | PNP/PNP | NPN/PNP | Package |
|-------------|---------|-------|------------|------------|---------------------------|
| | NXP | JEITA | complement | complement | configuration |
| PEMH9 | SOT666 | - | PEMB9 | PEMD9 | ultra small and flat lead |
| PIMH9 | SOT457 | SC-74 | - | - | small |
| PUMH9 | SOT363 | SC-88 | PUMB9 | PUMD9 | very small |

1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
 - Reduces pick and place costs
 - AEC-Q101 qualified

1.3 Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

1.4 Quick reference data

Table 2. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------|---------------------------|------------|-----|-----|-----|------|
| Per transis | stor | | | | | |
| V_{CEO} | collector-emitter voltage | open base | - | - | 50 | V |
| Io | output current | | - | - | 100 | mA |
| R1 | bias resistor 1 (input) | | 7 | 10 | 13 | kΩ |
| R2/R1 | bias resistor ratio | | 3.7 | 4.7 | 5.7 | |



2. Pinning information

Table 3. Pinning

| Table 3. | Filling | | |
|----------|------------------------|--------------------|-----------------|
| Pin | Description | Simplified outline | Graphic symbol |
| 1 | GND (emitter) TR1 | | |
| 2 | input (base) TR1 | 6 5 4 | 6 5 4 |
| 3 | output (collector) TR2 | | |
| 4 | GND (emitter) TR2 | | R1 R2 |
| 5 | input (base) TR2 | | TR1 |
| 6 | output (collector) TR1 | 001aab555 | R2 R1 |
| | | | 1 2 3 sym063 |

3. Ordering information

Table 4. Ordering information

| Type number | Package | | |
|-------------|---------|--|---------|
| | Name | Description | Version |
| РЕМН9 | - | plastic surface-mounted package; 6 leads | SOT666 |
| PIMH9 | SC-74 | plastic surface-mounted package (TSOP6); 6 leads | SOT457 |
| PUMH9 | SC-88 | plastic surface-mounted package; 6 leads | SOT363 |

4. Marking

Table 5. Marking codes

| Type number | Marking code ^[1] |
|-------------|-----------------------------|
| РЕМН9 | H9 |
| PIMH9 | H9 |
| PUMH9 | H*9 |

^{[1] * =} placeholder for manufacturing site code

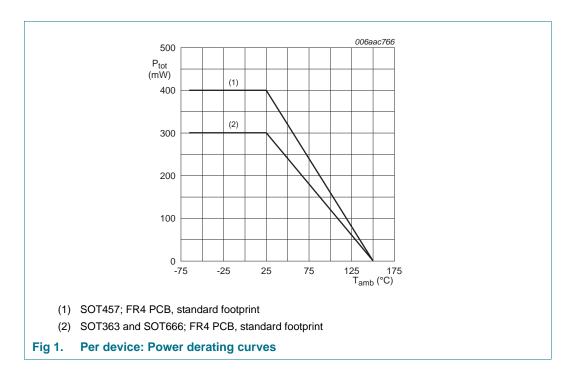
5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------------|--------------------------------------|--------------|------|------|
| Per transis | stor | | | | |
| V_{CBO} | collector-base voltage | open emitter | - | 50 | V |
| V_{CEO} | collector-emitter voltage | open base | - | 50 | V |
| V_{EBO} | emitter-base voltage | open collector | - | 6 | V |
| V_{I} | input voltage | | | | |
| | positive | | - | +40 | V |
| | negative | | - | -6 | V |
| Io | output current | | - | 100 | mA |
| I _{CM} | peak collector current | single pulse; $t_p \le 1 \text{ ms}$ | - | 100 | mA |
| P _{tot} | total power dissipation | $T_{amb} \le 25 ^{\circ}C$ | | | |
| | PEMH9 (SOT666) | | <u>[1]</u> - | 200 | mW |
| | PIMH9 (SOT457) | | <u>[1]</u> | 250 | mW |
| | PUMH9 (SOT363) | | <u>[1]</u> - | 200 | mW |
| Per device |) | | | | |
| P _{tot} | total power dissipation | $T_{amb} \le 25 ^{\circ}C$ | | | |
| | PEMH9 (SOT666) | | <u>[1]</u> - | 300 | mW |
| | PIMH9 (SOT457) | | <u>[1]</u> | 400 | mW |
| | PUMH9 (SOT363) | | <u>[1]</u> - | 300 | mW |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -55 | +150 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

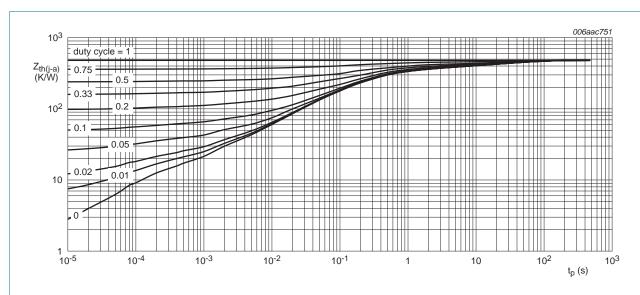


6. Thermal characteristics

Table 7. Thermal characteristics

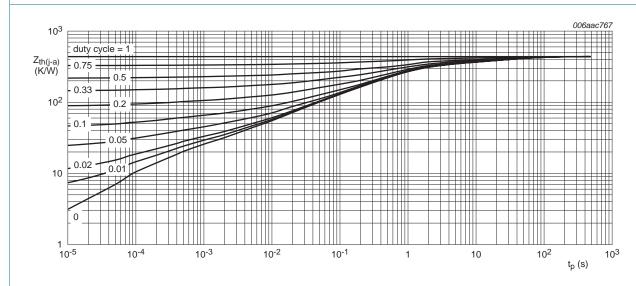
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|---|-------------|--------------|-----|-----|------|
| Per transis | stor | | | | | |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | | | | |
| | PEMH9 (SOT666) | | <u>[1]</u> _ | - | 625 | K/W |
| | PIMH9 (SOT457) | | <u>[1]</u> - | - | 500 | K/W |
| | PUMH9 (SOT363) | | <u>[1]</u> - | - | 625 | K/W |
| Per device |) | | | | | |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | | | | |
| | PEMH9 (SOT666) | | [1] - | - | 417 | K/W |
| | PIMH9 (SOT457) | | <u>[1]</u> - | - | 313 | K/W |
| | PUMH9 (SOT363) | | <u>[1]</u> - | _ | 417 | K/W |

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



FR4 PCB, standard footprint

Fig 2. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration for PEMH9 (SOT666); typical values



FR4 PCB, standard footprint

Fig 3. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration for PIMH9 (SOT457); typical values

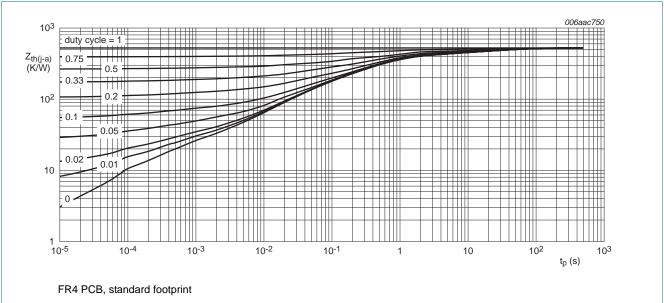


Fig 4. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration for PUMH9 (SOT363); typical values

NPN/NPN resistor-equipped transistors; R1 = 10 kΩ, R2 = 47 kΩ

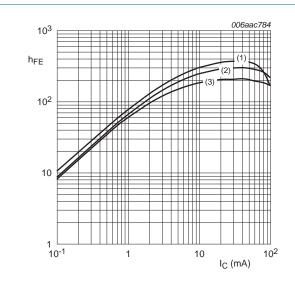
7. Characteristics

Table 8. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

| Symbol | Parameter | Conditions | N | Min | Тур | Max | Unit |
|------------------|--------------------------------------|---|-------|-----|-----|-----|------|
| Per trans | sistor | | | | | | |
| I _{CBO} | collector-base cut-off current | $V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$ | - | | - | 100 | nA |
| I _{CEO} | collector-emitter cut-off | $V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A}$ | - | | - | 100 | nA |
| | current | $V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A};$ $T_{j} = 150 ^{\circ}\text{C}$ | - | | - | 5 | μΑ |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$ | - | | - | 150 | μΑ |
| h _{FE} | DC current gain | $V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$ | 1 | 100 | - | - | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 5 \text{ mA}; I_B = 0.25 \text{ mA}$ | - | | - | 100 | mV |
| $V_{I(off)}$ | off-state input voltage | $V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$ | - | | 0.7 | 0.5 | V |
| $V_{I(on)}$ | on-state input voltage | $V_{CE} = 0.3 \text{ V}; I_{C} = 1 \text{ mA}$ | 1 | 1.4 | 0.8 | - | V |
| R1 | bias resistor 1 (input) | | 7 | 7 | 10 | 13 | kΩ |
| R2/R1 | bias resistor ratio | | 3 | 3.7 | 4.7 | 5.7 | |
| C _c | collector capacitance | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz | - | | - | 2.5 | pF |
| f _T | transition frequency | $V_{CE} = 5 \text{ V; } I_{C} = 10 \text{ mA;}$ f = 100 MHz | [1] - | | 230 | - | MHz |

^[1] Characteristics of built-in transistor



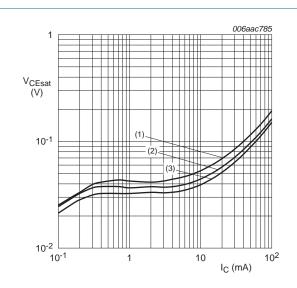
$$V_{CE} = 5 \text{ V}$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = -40 \, ^{\circ}C$

Fig 5. DC current gain as a function of collector current; typical values



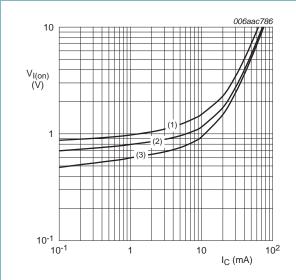
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 6. Collector-emitter saturation voltage as a function of collector current; typical values



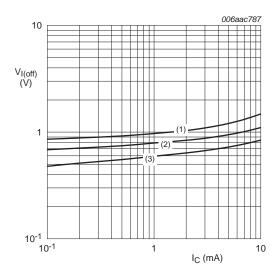
$$V_{CE} = 0.3 \text{ V}$$

(1)
$$T_{amb} = -40 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = 100 \, ^{\circ}C$

Fig 7. On-state input voltage as a function of collector current; typical values



$$V_{CE} = 5 V$$

(1)
$$T_{amb} = -40 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = 100 \, ^{\circ}C$

Fig 8. Off-state input voltage as a function of collector current; typical values

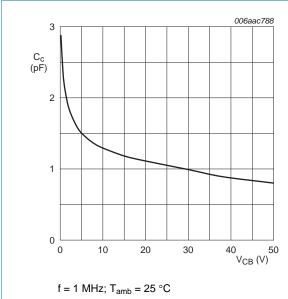


Fig 9. Collector capacitance as a function of collector-base voltage; typical values

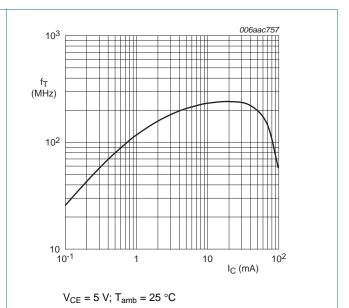


Fig 10. Transition frequency as a function of collector current; typical values of built-in transistor

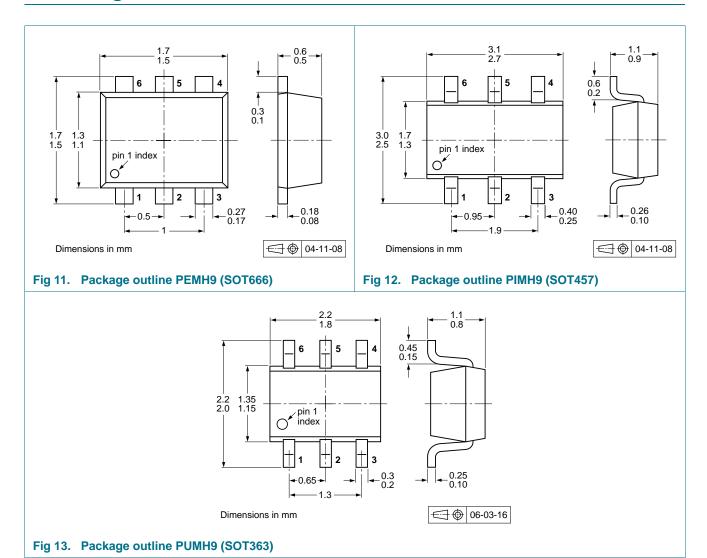
8. Test information

8.1 Quality information

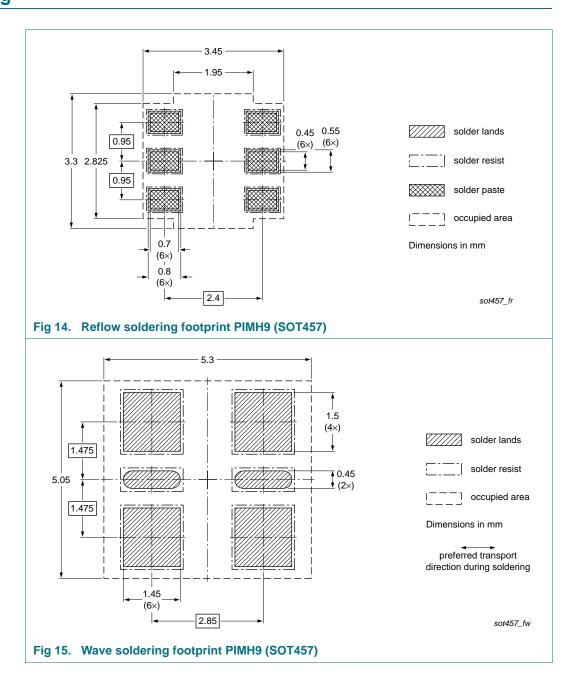
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

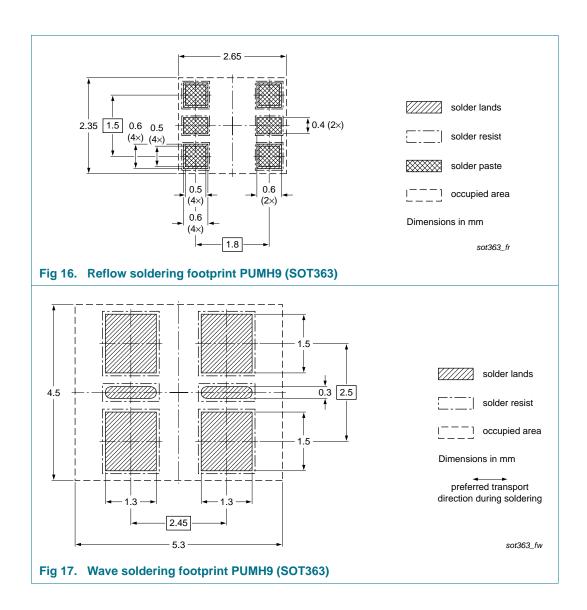
NPN/NPN resistor-equipped transistors; R1 = 10 kΩ, R2 = 47 kΩ

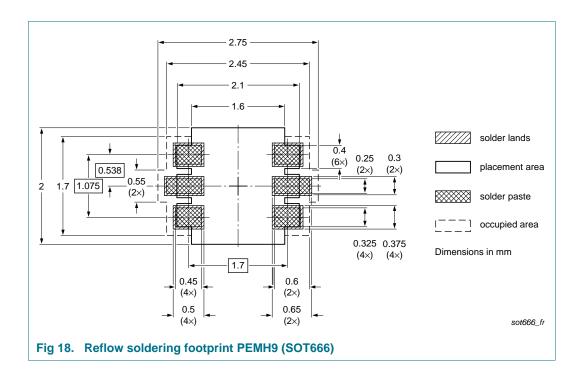
9. Package outline



10. Soldering







NPN/NPN resistor-equipped transistors; R1 = 10 kΩ, R2 = 47 kΩ

11. Revision history

Table 9. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|--|----------------------------|--|
| PEMH9_PIMH9_PUMH9 v.5 | 20131112 | Product data sheet | - | PIMH9_PUMH9_PEMH9 v.4 |
| Modifications: • The format of this document has been redesigned to comply with the new iden guidelines of NXP Semiconductors. | | | | |
| Legal texts have been adapted to the new company name where appropriate. | | | | |
| Section 1 "Product profile": updated | | | | |
| | Section 4 "M | larking": updated | | |
| | • Figure 1 to 1 | <u>0</u> : added | | |
| | Section 5 "Li | miting values": updated | | |
| | Section 6 "TI | hermal characteristics": updat | ed | |
| | • Table 8 "Cha | aracteristics": V _{i(on)} redefined t | o V _{I(on)} on-st | ate input voltage, V _{i(off)} redefined |
| | to V _{I(off)} off-s | tate input voltage, I _{CEO} update | ed, f _T added | |
| | Section 8 "Te | est information": added | | |
| | Section 9 "Page 12" | ackage outline": superseded l | oy minimized | I package outline drawings |
| | Section 10 "S | Soldering": added | | |
| | Section 12 "I | Legal information": updated | | |
| PIMH9_PUMH9_PEMH9 v.4 | 20040414 | Product data sheet | - | PIMH9_PUMH9_PEMH9 v.3 |
| PIMH9_PUMH9_PEMH9 v.3 | 20030915 | Product specification | | - |
| · · · · · · · · · · · · · · · · · · · | | | | |

12. Legal information

12.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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PEMH9_PIMH9_PUMH9

PEMH9; PIMH9; PUMH9

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

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PEMH9; PIMH9; PUMH9

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

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